

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	Heat Sink Riveted to Memory Module with Upper Slots and Open Bottom Edge for Air Flow	
Application Number :		
Date :		
First Named Applicant:	Ren-Kang Chiou	
Confirmation Number:		
Attorney Docket Number:	ML-16	
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Submitted By:		Elec. Sign.
Stuart T Auvinen		/e/stuauvinen
Registered Number: 36,435		Sign. Capacity Agent

Documents being submitted:	Files
us-ids	ML16ex-usidst.xml us-ids.dtd us-ids.xsl
us-request	ML16ex-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	ML16ex-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
application-body	ML16e-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd fgML16e01.TIF fgML16e02.TIF fgML16e03.TIF fgML16e04.TIF OathML16e.tif
us-declaration	
Comments	